



Specs

Orderable Parts for: MT29F16G08CBABAWP-IT

SEE ALL MLC NAND PARTS

	Status	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
MT29F16G08CBABAWP- IT:B	Obsolete	N/A	N/A	N/A	N/A	No		VIEW

Detailed Specifications

Density	16Gb	Status	Obsolete	NAND Type		RoHS	Yes	
Width	x8	Voltage	3.3V	Package	TSOP	Pin Count	48-pin	
Op. Temp.	-40C to +85C	MT/s		I/O	Common	Product Name		

Sim Models & Software

Sim Models



IBIS: NAND 16Gb MLC (Rev B) L62A (ZIP)

MLC NAND NAND Flash

Rev. 2.1

File Type: ZIP

Updated: 11/30/2012

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Verilog: NAND 16Gb, MLC (rev B) (ZIP)

16Gb MLC NAND Verilog Model

File Type: ZIP

Updated: 12/31/2009

MLC NAND NAND Flash

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Software

Software Support Pack

mtd-nand-use-a-lower-value-for-badblockbits-when-working-with-MLC-NAND (ZIP)

MLC NAND NAND Flash

MLC NANDs have more bit flips that SLC. When looking for bad block marker we have a lot of false positive if we check for the whole byte. To avoid this tolerate a few (4 here) bit flips for byte.

File Type: ZIP

Updated: 03/31/2016

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Software Support Pack

NAND FLASH lockunlock bug fix (ZIP)

Reset NAND before write protect check.

NAND Flash SLC NAND

MLC NAND

File Type: ZIP **Updated:** 03/31/2016

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Software Support Pack

UBI power loss issue for paired page Ver2.0 (ZIP)

MLC NAND NAND Flash

These patches aim to solve MLC NAND paired page power loss issue by adding a bakvol (backup volume) module in UBI layer. 70 series and 80 series families.

File Type: ZIP

Updated: 03/31/2016

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fixup-ubi-cannot-recover-master node issue (ZIP)

MLC NAND NAND Flash

For MLC NAND, paired page issue is now a common known issue. This patch is just for master node cannot be recovered while there will two pages be dameged in one single master block.

File Type: ZIP

Updated: 03/31/2016

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Software Support Pack

YAFFS mark bad block issue (ZIP)

MLC NAND NAND Flash SLC NAND

If the bitflips num over mtd->bitflip_threshold the mtd_read_oob will return -EUCLEAN and tags->ecc_result > YAFFS_ECC_RESULT_NO_ERROR. Then we will call yaffs_handle_chunk_error.

File Type: ZIP

Updated: 03/31/2016

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RoHS Certificates

RoHS Certificates

RoHS Certificate of Compliance (PDF)

MT29F16G08CBABAWP-IT

Part-specific certification of how this product meets the requirements of the current DIRECTIVE 2002/95/EC, a.k.a. Restriction of Hazardous Substances (RoHS) Directive.

File Type: (PDF)

Updated: 05/2017

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RoHS Certificates

China RoHS Certificate (PDF)

MT29F16G08CBABAWP-IT

Part-specific certification as required by China's Management Methods for Controlling Pollution by Electronic Information Products.

File Type: (PDF)

Updated: 05/2017

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Documentation & Support

See All MLC NAND Documentation

Technical Notes

SEARCH (4) MLC NAND TECHNICAL NOTES



TN-00-33: Power Integrity Simulation with IBIS 5.0 Models (PDF)

(TN-00-33) This technical note describes the new features in IBIS 5.0 enabling PI simulation. It also provides an overview of some of the modeling accuracy challenges and compares SSO simulation results using various electronic design automation (EDA) software tools.

File Type: PDF

Updated: 01/25/2016

3D NAND DDR3 SDRAM DDR4 SDRAM DRAM See More Tags

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Technical Notes

TN-00-01: Moisture Sensitivity of Plastic Packages (PDF)

(TN-00-01) This technical note describes shipping procedures for preventing memory devices from absorbing moisture and recommendations for baking devices exposed to excessive moisture.

File Type: PDF

Updated: 02/14/2013

DDR SDRAM DDR2 SDRAM DDR3 SDRAM DDR3L-RS See More Tags

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Technical Notes

TN-29-65: Software Device Drivers for Very Large Page Micron NAND Flash Memory (PDF)

MLC NAND NAND Flash SLC NAND

(TN-29-65) Download the low-level driver described in this document here.

File Type: PDF

Updated: 10/15/2010

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Technical Notes

TN-29-61: Wear Leveling in NAND Flash Memory (PDF)

MLC NAND NAND Flash SLC NAND

(TN-29-61) This technical note describes the recommended wear leveling algorithm to be implemented in the FTL software for NAND Flash memory.

File Type: PDF

Updated: 10/15/2010

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SEARCH (4) MLC NAND TECHNICAL NOTES

Parts with the same Data Sheet (3)

	MT29F16G08CBABAWP-IT (Current)		MT29F16G08CBABAC3	MT29F16G08CBABAL62A3W C1	MT29F16G08CBABAWP		
	Status	Obsolete	Obsolete	Obsolete	Obsolete		
	Density	16Gb	16Gb	16Gb	16Gb		
Dow	nloaded from A	rrow.com.					

NAND Type	2D	2D	2D	2D Yes		
RoHS	Yes	Yes	Yes			
Width	х8	x8	x8	x8		
Voltage	3.3V	3.3V	3.3V	3.3V		
Package	ckage TSOP ULGA		Wafer	TSOP		
Pin Count	48-pin	52-pad	n/a	48-pin		
Op. Temp.	-40C to +85C	0C to +70C	0C to +70C	0C to +70C		
	MT/s					
I/O	Common	Common	Common	Common		
Product Name						

MT29F16G08CBABAWP-IT

(Current)

`	,										
Status	Obsolete		Where to Buy								
Density	16Gb										
NAND Type	2D										
RoHS	Yes	Status	Media	FBGA Code	SP Da		Chipset Validation	PLP	Start Date		
Width	х8				_ = ====						
Voltage	3.3V	bsolete	N/A	N/A	N/	'A	N/A	No			
Package	TSOP										
Pin Count	48-pin										
Op. Temp.	-40C to +85C		- OR - Check with Distributors						ors		
	MT/s		Your Region: Americas								
1/0	Common					WDVI					
Pr	Product Name					, u	4600				

See All Distributors

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